

SiHFP264-VB Datasheet N-Channel 250 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ)			
250	0.040 at V _{GS} = 10 V	60	95			
	0.045 at V _{GS} = 6 V	55	90			

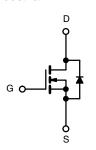
FEATURES

- Trench Power MOSFETS
- 175 °C Junction Temperature
- · New Low Thermal Resistance Package
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

Industrial



N-Channel MOSFET

TO-247AC
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Top View

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \, ^{\circ}C$, unless otherwise noted) **Parameter Symbol** Limit Unit Drain-Source Voltage V_{DS} 250 Gate-Source Voltage V_{GS} ± 30 T_C = 25 °C Continuous Drain Current (T_J = 175 °C) I_D T_C = 125 °C 35 Α **Pulsed Drain Current** I_{DM} 200 35 **Avalanche Current** I_{AR} L = 0.1 mH E_AR 61 Repetitive Avalanche Energy^a mJ T_C = 25 °C 300^b P_D Maximum Power Dissipation^a W $T_A = 25 \, ^{\circ}C^{c}$ 3.75 °С Operating Junction and Storage Temperature Range T_J , T_{stg} - 55 to 175

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.5	C/VV	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	250			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 30 \text{ V}$			± 250	nA	
		V _{DS} = 250 V, V _{GS} = 0 V			1	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 250 V, V _{GS} = 0 V, T _J = 125 °C			50 μΑ		
		$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	70			Α	
		V _{GS} = 10 V, I _D = 30 A		0.040			
	D	$V{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 ^{\circ}\text{C}$		0.091			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175 ^{\circ}\text{C}$		0.123		Ω	
		$V_{GS} = 6 \text{ V}, I_D = 25 \text{ A}$		0.045			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A		70		S	
Dynamic ^b	*			*			
Input Capacitance	C _{iss}			5000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		300			
Reverse Transfer Capacitance	C _{rss}			170			
Total Gate Charge ^c	Q_g			95	140		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 125 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 45 \text{ A}$		28		nC	
Gate-Drain Charge ^c	Q_{gd}			34			
Gate Resistance	R_{g}	f = 1 MHz		1.6		Ω	
Turn-On Delay Time ^c	t _{d(on)}			22	35		
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 2.78 \Omega$		220	330	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 45 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		40	60		
Fall Time ^c	t _f			145	220		
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C) ^b		•			
Continuous Current	I _S				45	۸	
Pulsed Current	I _{SM}				70	Α	
Forward Voltage ^a	V_{SD}	I _F = 45 A, V _{GS} = 0 V		1	1.5	٧	
Reverse Recovery Time	t _{rr}			150	225	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 45 A, di/dt = 100 A/μs		12	18	Α	
Reverse Recovery Charge	Q _{rr}			0.9	2	μC	

Notes

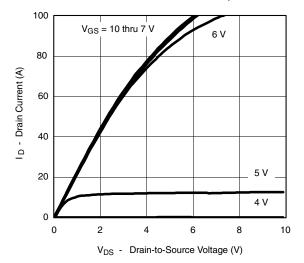
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

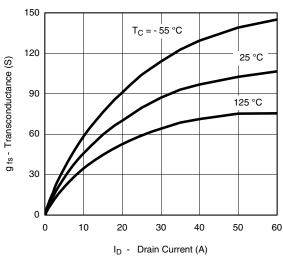
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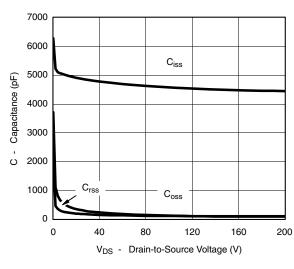
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



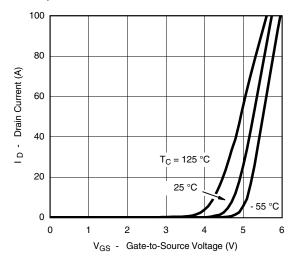
Output Characteristics



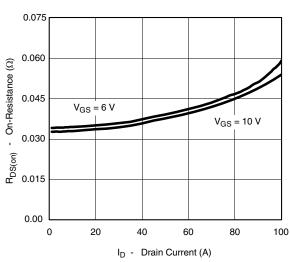
Transconductance



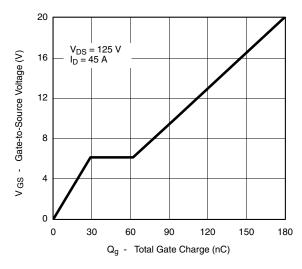
Capacitance



Transfer Characteristics



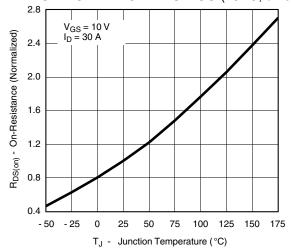
On-Resistance vs. Drain Current



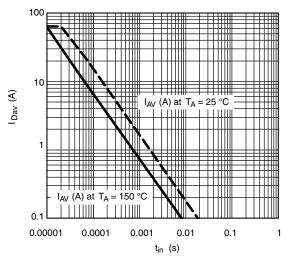
Gate Charge



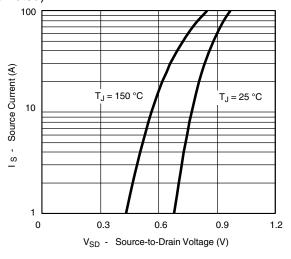
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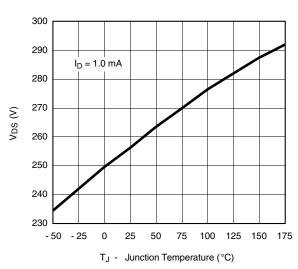
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



Source-Drain Diode Forward Voltage

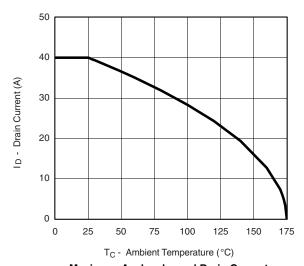


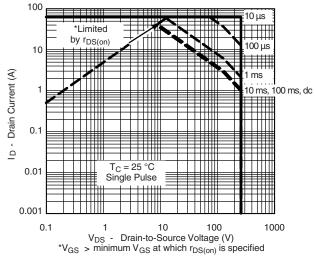
Drain Source Breakdown vs. Junction Temperature

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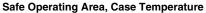


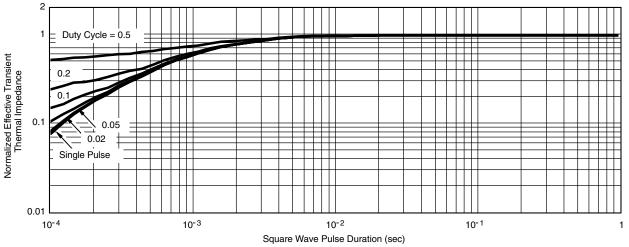
THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature





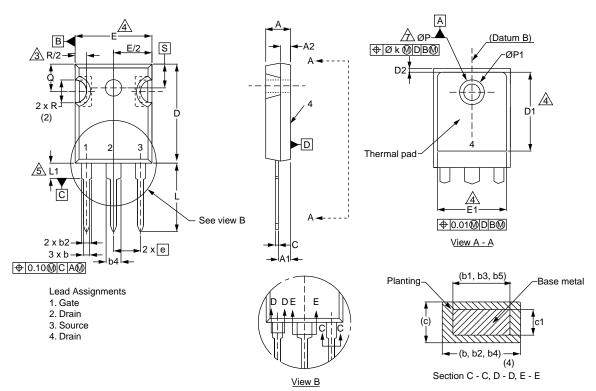
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-247AC (High Voltage)



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	-	0.515	-

	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
D2	0.51	1.30	0.020	0.051		
E	15.29	15.87	0.602	0.625		
E1	13.72	-	0.540	-		
е	5.46	5.46 BSC 0.215 BSC		5.46 BSC		BSC
Øk	0.254		0.010			
L	14.20	16.25	0.559	0.640		
L1	3.71	4.29	0.146	0.169		
N	7.62 BSC		0.300 BSC			
ØΡ	3.51	3.66	0.138	0.144		
Ø P1	-	7.39	-	0.291		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51	5.51 BSC		0.217 BSC		

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